

# DATA SHEET

Part No.	AN13300A
Package Code No.	*SOP022 - P - 0375C

SEMICONDUCTOR COMPANY  
MATSUSHITA ELECTRIC INDUSTRIAL CO., LTD.

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# AN13300A

## Silicon Monolithic Bipolar IC

### ■ Features

- Video signal input - output interface for DSP

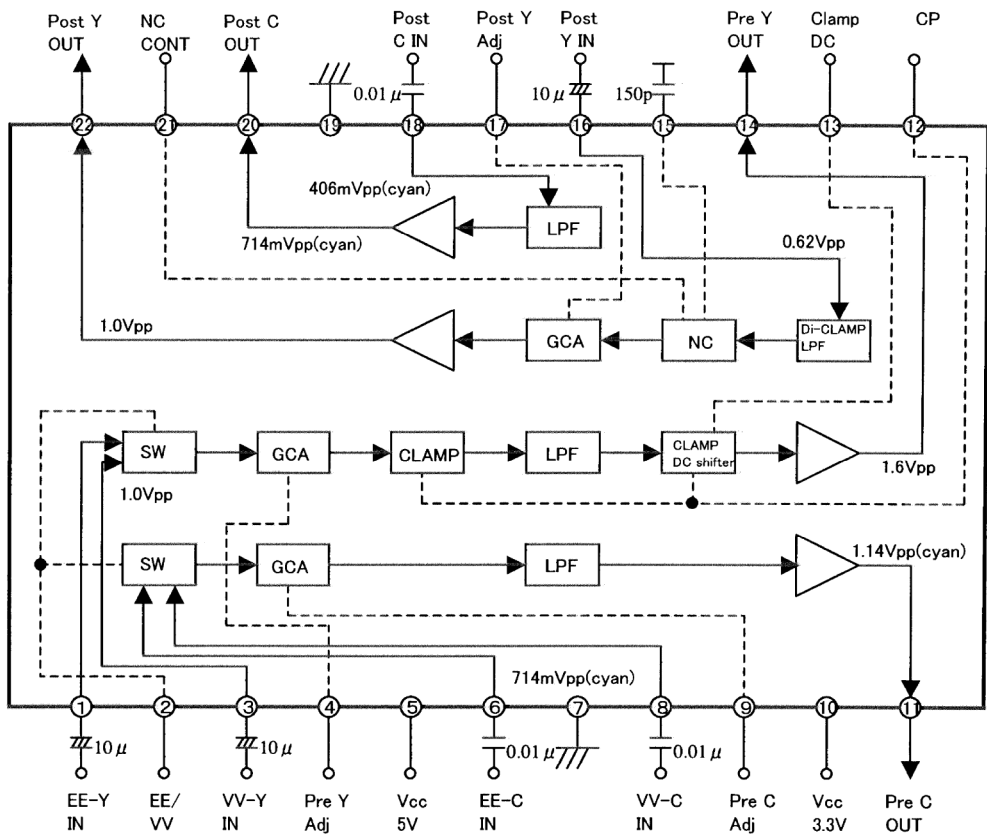
### ■ Applications

- VCR ( Digital Video equipment )

### ■ Package

- Dill - 22Pin plastic package SO Type

■ Block Diagram



■ Pin Descriptions

Pin No.	Function	Impedance	Pin No.	Function	Impedance
1	EE - Y IN	30k	12	Clamp Pulse IN	210k
2	EE / VV SW	210k	13	Clamp DC	65k
3	VV - Y IN	30k	14	Pre - Y OUT	E. F.
4	Pre - Y Adj.	64k	15	N. C. Capacitor	500k
5	V <sub>CC1</sub> ( 5V )	—	16	Post - Y IN	26k
6	EE - C IN	30k	17	Post - Y Adj.	65k
7	GND	—	18	Post - C IN	21k
8	VV - C IN	10k	19	GND	—
9	Pre - C Adj.	62k	20	Post - C OUT	E. F.
10	V <sub>CC2</sub> ( 3.3 V )	—	21	N. C. Control	65k
11	Pre - C OUT	E. F.	22	Post - Y OUT	E. F.

# Absolute Maximum Ratings

No.	Parameter	Symbol	Rating		Unit	Note
1	Storage temperature	$T_{\text{stg}}$	−55 to +125		°C	*
2	Operating ambient temperature	$T_{\text{opr}}$	−20 to +70		°C	*
3	Operating ambient atmospheric pressure	$P_{\text{opr}}$	$1.013 \times 10^5 \pm 0.61 \times 10^5$		Pa	
4	Operating constant gravity	$G_{\text{opr}}$	9 810		m/S <sup>2</sup>	
5	Operating shock	$S_{\text{opr}}$	4 900		m/S <sup>2</sup>	
6	Supply voltage	$V_{\text{CC}}$	$V_{\text{CC1}}$	5.5	V	
			$V_{\text{CC2}}$	3.6		
7	Supply current	$I_{\text{CC}}$	$I_{\text{CC1}}$	35	mA	
			$I_{\text{CC2}}$	0.5		
8	Power dissipation	$P_{\text{D}}$	195		W	

Note) \*: Expect for the operating ambient temperature and storage temperature , all ratings are for  $T_a = 25^\circ\text{C}$ .

# Operating Supply Voltage Range

Operating supply voltage range	$V_{\text{CC1}}$	4.75 V to 5.25 V
	$V_{\text{CC2}}$	3.1 V to 3.5 V

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